

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	TIEN-JEN CHANG, ET AL.)	
)	Group Art Unit: 1753
Serial No.:	10/707,047)	
)	
Filed:	November 18, 2003)	Examiner: Van, L.
)	
For:	METHOD FOR SELECTIVE ELECTRO-)	
	PLATING OF SEMICONDUCTOR)	Confirmation No.: 1046
	DEVICE I/O PADS USING A)	
	TITANIUM-TUNGSTEN SEED LAYER)	

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Office Action mailed May 4, 2006, please amend the
Application as follows: